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Bridgelux® SMD 3030 Series

Product Data Sheet DS51

SMD 3030



Introduction

The Bridgelux SMD 3030 offers exceptional performance in a compact LED package. This mid power LED is hot-color targeted which ensures that the LEDs fall within their specified color bin at the typical application conditions of 85°C. With its broad lumen coverage and wide range of CCT options, the SMD 3030 provides unparalleled design-in flexibility for indoor and outdoor lighting applications. Its high flux capability reduces the number of LEDs and enables industry leading system level lumen per dollar. The SMD 3030 is ideal as a drop in replacement for emitters with an industry standard 3.0mm x 3.0mm footprint.

Features

- Competitive efficacy and lumen per dollar
- Industry-standard 3030 footprint
- Excellent color maintenance
- 9 bin color control enables tight color control
- Superior luminous flux at maximum current for reduced LED count
- Hot-color targeting ensures that color is within the ANSI bin at the typical application conditions of 85°C
- Enables 3- and 5-step MacAdam ellipse custom binning kits
- RoHS compliant and Lead free
- Multiple CCT and CRI configurations for a wide range of lighting applications

Benefits

- Lower operating and manufacturing cost
- Ease of design and rapid go-to-market
- Uniform consistent white light
- Reliable and constant white point
- Environmentally friendly, complies with standards
- Design flexibility



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Product Feature Map

Bridgelux SMD LED products offer exceptional performance and color quality all in a highly reliable, cost effective, compact package. Our SMD products come in industry standard package sizes and follow ANSI binning standards. These LEDs are optimized for cost and performance. helping to ensure highly competitive system lumen per dollar performance while addressing the stringent efficacy and reliability standards required for modern lighting applications.



Product Nomenclature

The part number designation for Bridgelux SMD 3030 is explained as follows:



Product Test Conditions

Bridgelux SMD 3030 LEDs are tested and binned with a 10ms pulse of 150mA at T_j (junction temperature)-T_{sp} (solder point temperature) -25°C. Forward voltage and luminous flux are binned at a T₁-T_{sp}-25°C, while color is hot targeted at a T_{sp} of 85°C.

Product Selection Guide

The following product configurations are available:

Table 1: Selection Guide, Pulsed Measurement Data at 150mA ($T_j = T_{sp} = 25^{\circ}C$)
--

Part Number ^{1.6}	Nominal CCT ²	CRI ^{3, 5}	Nominal Drive Current	minal Forward Voltage4.5 Current (V)		Forward Voltage ^{4.5} Minimum Typical (V) Pulsed Flux Pulsed Flux		Typical Power	Typical Efficacy	
	(K)		(mA)	Min	Typical	Max	(lm) ^{4.5.7}	(lm)4.5	(W/)	(lm/W)
BXEM-27C0000-0-000	2700	70	150	5.8	6.25	6.6	110	123	0.9	131
BXEM-27E0000-0-000	2700	80	150	5.8	6.25	6.6	100	117	0.9	125
BXEM-27G0000-0-000	2700	90	150	5.8	6.25	6.6	80	98	0.9	105
BXEM-30C0000-0-000	3000	70	150	5.8	6.25	6.6	110	126	0.9	134
BXEM-30E0000-0-000	3000	80	150	5.8	6.25	6.6	110	123	0.9	131
BXEM-30G0000-0-000	3000	90	150	5.8	6.25	6.6	90	103	0.9	110
BXEM-35C0000-0-000	3500	70	150	5.8	6.25	6.6	110	129	0.9	138
BXEM-35E0000-0-000	3500	80	150	5.8	6.25	6.6	110	125	0.9	133
BXEM-35G0000-0-000	3500	90	150	5.8	6.25	6.6	90	105	0.9	112
BXEM-40C0000-0-000	4000	70	150	5.8	6.25	6.6	120	133	0.9	142
BXEM-40E0000-0-000	4000	80	150	5.8	6.25	6.6	110	127	0.9	135
BXEM-40G0000-0-000	4000	90	150	5.8	6.25	6.6	90	108	0.9	115
BXEM-50C0000-0-000	5000	70	150	5.8	6.25	6.6	120	133	0.9	142
BXEM-50E0000-0-000	5000	80	150	5.8	6.25	6.6	110	127	0.9	135
BXEM-50G0000-0-000	5000	90	150	5.8	6.25	6.6	90	108	0.9	115
BXEM-57C0000-0-000	5700	70	150	5.8	6.25	6.6	120	133	0.9	142
BXEM-57E0000-0-000	5700	80	150	5.8	6.25	6.6	110	127	0.9	135
BXEM-57G0000-0-000	5700	90	150	5.8	6.25	6.6	90	108	0.9	115
BXEM-65C0000-0-000	6500	70	150	5.8	6.25	6.6	120	133	0.9	142
BXEM-65E0000-0-000	6500	80	150	5.8	6.25	6.6	110	126	0.9	134
BXEM-65G0000-0-000	6500	90	150	5.8	6.25	6.6	90	108	0.9	115

Notes for Table 1:

1. The last 10 characters (including hyphens '-') refer to nominal flux, nominal forward voltage, and color bins, respectively. "0000-0-000" denotes the full distribution of flux, forward voltage, and 7 SDCM color.

Example: BXEM-30E0000-0-000 refers to the full distribution of flux, forward voltage, and color within a 3000K 7-step ANSI standard chromaticity region with a minimum of 80CRI.

2. Product CCT is hot targeted at T_{sp} = 85°C. Nominal CCT as defined by ANSI C78.377-2011.

3. Listed CRIs are minimum values and include test tolerance.

4. Products tested under pulsed condition (10ms pulse width) at nominal drive current where T_i=T_{so}=25°C.

 Bridgelux maintains a ±7.5% tolerance on luminous flux measurements, ±0.1V tolerance on forward voltage measurements, and ±2 tolerance on CRI measurements for the SMD 3030.

6. Refer to Table 6 and Table 7 for Bridgelux SMD 3030 Luminous Flux Binning and Forward Voltage Binning information.

7. Minimum flux values at elevated temperatures are provided for reference only and are not guaranteed by 100% production testing.

Product Selection Guide

Part Number15	Nominal CCT ² CRI ^{3.4}		Nominal CCT ² (V) CRI ^{3.4} Drive Current		F	Forward Voltage4 (V)		Minimum DC Flux	Typical DC	Typical DC Flux (Im)4	Typical Efficacy
	(K)		(mA)	Min	Typical	Max	(lm)4.8	Flux (lm)*	(W/)	(lm/W)	
BXEM-27C0000-0-000	2700	70	150	5.6	6.0	6.4	91	102	0.9	113	
BXEM-27E0000-0-000	2700	80	150	5.6	6.0	6.4	85	99	0.9	111	
BXEM-27G0000-0-000	2700	90	150	5.6	6.0	6.4	68	83	0.9	93	
BXEM-30C0000-0-000	3000	70	150	5.6	6.0	6.4	91	105	0.9	116	
BXEM-30E0000-0-000	3000	80	150	5.6	6.0	6.4	94	105	0.9	116	
BXEM-30G0000-0-000	3000	90	150	5.6	6.0	6.4	77	88	0.9	97	
BXEM-35C0000-0-000	3500	70	150	5.6	6.0	6.4	92	108	0.9	120	
BXEM-35E0000-0-000	3500	80	150	5.6	6.0	6.4	92	105	0.9	117	
BXEM-35G0000-0-000	3500	90	150	5.6	6.0	6.4	77	90	0.9	100	
BXEM-40C0000-0-000	4000	70	150	5.6	6.0	6.4	101	112	0.9	124	
BXEM-40E0000-0-000	4000	80	150	5.6	6.0	6.4	92	107	0.9	119	
BXEM-40G0000-0-000	4000	90	150	5.6	6.0	6.4	77	93	0.9	103	
BXEM-50C0000-0-000	5000	70	150	5.6	6.0	6.4	102	113	0.9	126	
BXEM-50E0000-0-000	5000	80	150	5.6	6.0	6.4	92	107	0.9	119	
BXEM-50G0000-0-000	5000	90	150	5.6	6.0	6.4	77	92	0.9	102	
BXEM-57C0000-0-000	5700	70	150	5.6	6.0	6.4	102	113	0.9	126	
BXEM-57E0000-0-000	5700	80	150	5.6	6.0	6.4	92	107	0.9	119	
BXEM-57G0000-0-000	5700	90	150	5.6	6.0	6.4	77	92	0.9	102	
BXEM-65C0000-0-000	6500	70	150	5.6	6.0	6.4	102	113	0.9	126	
BXEM-65E0000-0-000	6500	80	150	5.6	6.0	6.4	91	105	0.9	116	
BXEM-65G0000-0-000	6500	90	150	5.6	6.0	6.4	77	92	0.9	102	

Table 2: Selection Guide, Stabilized DC Performance $(T_{sp} = 85^{\circ}C)^{6.7}$

Notes for Table 2:

1. The last 10 characters (including hyphens '-') refer to nominal flux, nominal forward voltage, and color bins, respectively. "0000-0-000" denotes the full distribution of flux, forward voltage, and 7 SDCM color.

Example: BXEM-30E0000-0-000 refers to the full distribution of flux, forward voltage, and color within a 3000K 7-step ANSI standard chromaticity region with a minimum of 80CRI.

- 2. Product CCT is hot targeted at T_{sp} = 85°C. Nominal CCT as defined by ANSI C78.377-2011.
- 3. Listed CRIs are minimum values and include test tolerance.

 Bridgelux maintains a ±75% tolerance on luminous flux measurements, ±0.1V tolerance on forward voltage measurements, and ±2 tolerance on CRI measurements for the SMD 3030.

5. Refer to Table 6 and Table 7 for Bridgelux SMD 3030 Luminous Flux Binning and Forward Voltage Binning information.

6. Typical stabilized DC performance values are provided as reference only and are not a guarantee of performance.

7. Typical performance is estimated based on operation under DC (direct current) with LED emitter mounted onto a heat sink with thermal interface material and the solder point temperature maintained at 85°C. Based on Bridgelux test setup, values may vary depending on the thermal design of the luminaire and/or the exposed environment to which the product is subjected.

8. Minimum flux values at elevated temperatures are provided for reference only and are not guaranteed by 100% production testing.

SMD 3030 LEDs are tested to the specifications shown using the nominal drive currents in Table 1. SMD 3030 may also be driven at other drive currents dependent on specific application design requirements. The performance at any drive current can be derived from the current vs. voltage characteristics shown in Figure 2 and the relative luminous flux vs. current characteristics shown in Figure 3. The performance at commonly used drive currents is summarized in Table 3.

Part Number	CRI	Drive Current¹ (mA)	Typical V _f T _{sp} = 25°C (V)	Typical Power T _{sp} = 25°C (W)	Typical Pulsed Flux ² T _{sp} = 25°C (lm)	Typical DC Flux³ T _{sp} = 85°C (lm)	Typical Efficacy T _{sp} = 25°C (lm/W)
		30	5.5	0.2	28	24	171
		60	5.7	0.3	55	47	159
BXEM-27C0000-0-000	70	100	6.0	0.6	87	74	145
B/EI*I-2/0000-0-000	70	150	6.25	0.9	123	102	131
		200	6.5	1.3	156	124	119
		240	6.7	1.6	179	138	111
		30	5.5	0.2	27	24	163
		60	5.7	0.3	52	46	152
EVEN 27E0000 0 000	80	100	6.0	0.6	82	72	138
BXEMI-2/E0000-0-000	00	150	6.25	0.9	117	99	125
	ĺ	200	6.5	1.3	148	121	114
		240	6.7	1.6	170	134	106
		30	5.5	0.2	22	20	136
		60	5.7	0.3	43	39	127
	90	100	6.0	0.6	69	60	116
BXEMI-2/G0000-0-000		150	6.25	0.9	98	83	105
		200	6.5	1.3	124	101	95
		240	6.7	1.6	142	112	88
		30	5.5	0.2	29	25	175
		60	5.7	0.3	56	49	163
RVEM 20Conco o coo	70	100	6.0	0.6	89	76	149
BALINI-30C0000-0-000	70	150	6.25	0.9	126	105	134
		200	6.5	1.3	159	127	122
		240	6.7	1.6	183	141	114
		30	5.5	0.2	28	25	171
		60	5.7	0.3	55	49	159
RVEM apEgaga a gag	80	100	6.0	0.6	87	76	145
BXEMI-30E0000-0-000	00	150	6.25	0.9	123	105	131
		200	6.5	1.3	156	127	119
		240	6.7	1.6	179	141	111
		30	5.5	0.2	23	21	143
		60	5.7	0.3	46	41	134
RVEM 20Coppo o opo		100	6.0	0.6	73	64	122
DVEIMI-3000000-0-000	90	150	6.25	0.9	103	88	110
		200	6.5	1.3	130	107	100
		240	6.7	1.6	150	118	93

Notes for Table 3:

1. Alternate drive currents in Table 3 are provided for reference only and are not a guarantee of performance.

2. Bridgelux maintains a ± 7.5% tolerance on flux measurements.

Performance at Commonly Used Drive Currents

Part Number	CRI	Drive Current¹ (mA)	Typical V _f T _{sp} = 25°C (V)	Typical Power T _{sp} = 25°C (W)	Typical Flux² T _{sp} = 25°C (lm)	Typical DC Flux ³ T _{sp} = 85°C (lm)	Typical Efficacy (lm/W)
		30	5.5	0.2	29	26	179
	[60	5.7	0.3	57	50	167
BXEM-25C0000-0-000	70	100	6.0	0.6	91	79	153
DVEINI-220000-0-000	/0	150	6.25	0.9	129	108	138
		200	6.5	1.3	163	132	125
		240	6.7	1.6	187	146	116
		30	5.5	0.2	28	25	174
		60	5.7	0.3	55	49	162
DVEM arEagon a good		100	6.0	0.6	88	76	148
BXEMI-35E0000-0-000	00	150	6.25	0.9	125	105	133
		200	6.5	1.3	158	128	121
		240	6.7	1.6	182	142	113
		30	5.5	0.2	24	21	146
		60	5.7	0.3	47	42	136
PVEM acConno o ono	90 -	100	6.0	0.6	74	66	124
BXEMI-3500000-0-000		150	6.25	0.9	105	90	112
		200	6.5	1.3	133	110	102
		240	6.7	1.6	153	122	95
	-	30	5.5	0.2	30	27	185
		60	5.7	0.3	59	52	172
RVEM 4000000 0.000	70	100	6.0	0.6	94	81	157
BALIMI-400000-0-000		150	6.25	0.9	133	112	142
		200	6.5	1.3	168	136	129
		240	6.7	1.6	193	151	120
		30	5.5	0.2	29	25	176
		60	5.7	0.3	56	50	165
RVEM 40E0000 0 000	80	100	6.0	0.6	90	77	150
BXEMI-40E0000-0-000	00	150	6.25	0.9	127	107	136
		200	6.5	1.3	161	130	123
		240	6.7	1.6	185	144	115
		30	5.5	0.2	25	22	150
		60	5.7	0.3	48	43	140
BVEM 4000000 0.000		100	6.0	0.6	76	67	128
BALMI-400000-0-000	90	150	6.25	0.9	108	93	115
		200	6.5	1.3	137	113	105
		240	6.7	1.6	157	125	97

Table 3: Performance at Commonly Used Drive Currents (Continued)

Notes for Table 3:

1. Alternate drive currents in Table 3 are provided for reference only and are not a guarantee of performance.

2. Bridgelux maintains a \pm 7.5% tolerance on flux measurements.

Performance at Commonly Used Drive Currents

Part Number	CRI	Drive Current¹ (mA)	Typical V _f T _{sp} = 25°C (V)	Typical Power T _{sp} = 25°C (W)	Typical Flux² T _{sp} = 25°C (lm)	Typical DC Flux ³ T _{sp} = 85°C (lm)	Typical Efficacy (lm/W)
		30	5.5	0.2	30	27	185
	[60	5.7	0.3	59	53	172
RVEM FOCODOD O DOD	70	100	6.0	0.6	94	82	157
BAEIMI-500000-0-000		150	6.25	0.9	133	113	142
		200	6.5	1.3	168	138	129
		240	6.7	1.6	193	152	120
		30	5.5	0.2	29	25	176
		60	5.7	0.3	56	50	165
BXEM-505000-0-000	80	100	6.0	0.6	90	77	150
BXEI*I-502000-0-000		150	6.25	0.9	127	107	136
		200	6.5	1.3	161	130	123
		240	6.7	1.6	185	144	115
		30	5.5	0.2	25	22	150
		60	5.7	0.3	48	43	140
RVEM FOCODOD O DOD	90 -	100	6.0	0.6	76	67	128
BXEM-50G0000-0-000		150	6.25	0.9	108	92	115
		200	6.5	1.3	137	112	105
		240	6.7	1.6	157	124	97
		30	5.5	0.2	30	27	185
		60	5.7	0.3	59	53	172
BXEM-570000-0-000	70	100	6.0	0.6	94	82	157
BAEI1-5/0000-0-000		150	6.25	0.9	133	113	142
		200	6.5	1.3	168	138	129
		240	6.7	1.6	193	152	120
		30	5.5	0.2	29	25	176
		60	5.7	0.3	56	50	165
BXFM-57F0000-0-000	80	100	6.0	0.6	90	77	150
		150	6.25	0.9	127	107	136
		200	6.5	1.3	161	130	123
		240	6.7	1.6	185	144	115
		30	5.5	0.2	25	22	150
		60	5.7	0.3	48	43	140
RVEN 5700000 0 000		100	6.0	0.6	76	67	128
BALIVI-5/00000-0-000	90	150	6.25	0.9	108	92	115
		200	6.5	1.3	137	112	105
		240	6.7	1.6	157	124	97

Table 3: Performance at Commonly Used Drive Currents (Continued)

Notes for Table 3:

1. Alternate drive currents in Table 3 are provided for reference only and are not a guarantee of performance.

2. Bridgelux maintains a ± 7.5% tolerance on flux measurements.

Performance at Commonly Used Drive Currents

Part Number	CRI	Drive Current¹ (mA)	Typical V _f T _{sp} = 25°C (V)	Typical Power T _{sp} = 25°C (W)	Typical Flux² T _{sp} = 25°C (lm)	Typical DC Flux³ T _{sp} = 85°C (lm)	Typical Efficacy (lm/W)
		30	5.5	0.2	30	27	185
		60	5.7	0.3	59	53	172
RVEM 65C0000 0.000	70	100	6.0	0.6	94	82	157
BALM-050000-0-000	/0	150	6.25	0.9	133	113	142
		200	6.5	1.3	168	138	129
		240	6.7	1.6	193	152	120
	80	30	5.5	0.2	29	25	175
		60	5.7	0.3	56	49	163
BXEM-65E0000-0-000		100	6.0	0.6	89	76	149
		150	6.25	0.9	126	105	134
		200	6.5	1.3	159	127	122
		240	6.7	1.6	183	141	114
		30	5.5	0.2	25	22	150
		60	5.7	0.3	48	43	140
EVEN 65C0000 0 000	00	100	6.0	0.6	76	67	128
DVENI-020000-0-000	90	150	6.25	0.9	108	92	115
		200	6.5	1.3	137	112	105
		240	6.7	1.6	157	124	97

Table 3: Performance at Commonly Used Drive Currents (Continued)

Notes for Table 3:

1. Alternate drive currents in Table 3 are provided for reference only and are not a guarantee of performance.

2. Bridgelux maintains a ± 7.5% tolerance on flux measurements.

Electrical Characteristics

Table 4: Electrical Characteristics

	Drive Current	I	Forward Voltage (V) ^{2,3}	e	Typical Temperature Coefficient	Typical Thermal Resistance	
Part Number 1	(mA)	Minimum	Typical	Maximum	of Forward Voltage ∆V,∕∆T (mV∕°C)	Junction to Solder Point ^{4.5} R _{j-sp} (C/W)	
BXEM-xxx0000-0-000	150	5.8	6.25	6.6	-2.0 to -4.0	12	

Notes for Table 4:

1. The 10 characters (including hyphens '-') refer to nominal flux, nominal forward voltage, and color bins, respectively. "0000-0-000" denotes the full distribution of flux, forward voltage, and 7 SDCM color.

Example: BXEM-30E0000-0-000 refers to the full distribution of flux, forward voltage, and color within a 3000K 7-step ANSI standard chromaticity region with a minimum of 80CRI.

2. Bridgelux maintains a tolerance of ± 0.1V on forward voltage measurements. Voltage minimum and maximum values at the nominal drive current are guaranteed by 100% test.

3. Products tested under pulsed condition (10ms pulse width) at nominal drive current where T_{sp} = 25°C.

4. Thermal Resistance values based on 3000K 80CRI product.

5. Thermal resistance value was calculated using total electrical input power; optical power was not subtracted from input power.

Absolute Maximum Ratings

Table 5: Maximum Ratings

Parameter	Maximum Rating
LED Junction Temperature (T _j)	125°C
Storage Temperature	-40°C to +100°C
Operating Solder Point Temperature (T _{sp})	-40°C to +100°C
Soldering Temperature	260°C or lower for a maximum of 10 seconds
Maximum Drive Current	240mA
Maximum Peak Pulsed Forward Current ¹	480mA
Maximum Reverse Voltage ²	-10V
Moisture Sensitivity Rating	MSL 3
Electrostatic Discharge	2kV HBM. JEDEC-JS-001-HBM and JEDEC-JS-001-2012

Notes for Table 5:

- 1. Bridgelux recommends a maximum duty cycle of 10% and pulse width of 10 ms when operating LED SMD at maximum peak pulsed current specified. Maximum peak pulsed currents indicate values where LED SMD can be driven without catastrophic failures.
- 2. Light emitting diodes are not designed to be driven in reverse voltage and will not produce light under this condition. Maximum rating provided for reference only.

Product Bin Definitions

Table 6 lists the standard photometric luminous flux bins for Bridgelux SMD 3030 LEDs. Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all CCTs.

Bin Code	Minimum	Maximum	Unit	Condition			
0060	60	70					
0070	70	80					
0080	80	90	- - - - lm				
0090	90	100		l _F =150mA			
0100	100	110					
0110	110	120					
0120	120	130					
0130	130	140					
0140	140	150					
0150	150	160					

Table 6: Luminous Flux Bin Definitions at 150mA, T_{sp} =25°C

Note for Table 6:

1. Bridgelux maintains a tolerance of ± 7.5% on luminous flux measurements.

Table 7: Forward Voltage Bin Definition

Bin Code	Minimum	Maximum	Unit	Condition	
Р	5.8	6.0			
Q	6.0	6.2		L 150mA	
R	6.2	6.4	v	IF=120111A	
S	6.4	6.6			

Note for Table 7:

1. Bridgelux maintains a tolerance of ± 0.1V on forward voltage measurements.

Product Bin Definitions

сст	Color Space	Center Point		Materia Anto	Network Andre	Ellipse	Color Dia	
		х	Y	Major Axis	MINOT AXIS	Rotation Angle	Color Bin	
	3 SDCM	0.4578	0.4101	0.00810	0.00420	53.70	270	
2/00K	5 SDCM	0.4578	0.4101	0.01350	0.00700	53.70	270/27A/27B/27C/27D	
	3 SDCM	0.4338	0.4030	0.00834	0.00408	53.22	300	
3000K	5 SDCM	0.4338	0.4030	0.01390	0.00680	53.22	300/30A/30B/30C/30D	
3500K	3 SDCM	0.4073	0.3917	0.00927	0.00414	54.00	350	
	5 SDCM	0.4073	0.3917	0.01545	0.00690	54.00	350/35A/35B/35C/35D	
4000K	3 SDCM	0.3818	0.3797	0.00939	0.00402	53.72	400	
	5 SDCM	0.3818	0.3797	0.01565	0.00670	53.72	400/40A/40B/40C/40D	
5000K	3 SDCM	0.3447	0.3553	0.00822	0.00354	59.62	500	
	5 SDCM	0.3447	0.3553	0.01370	0.00590	59.62	500/50A/50B/50C/50D	
5700K	3 SDCM	0.3287	0.3417	0.00746	0.00320	59.09	570	
	5 SDCM	0.3287	0.3417	0.01243	0.00533	59.09	570/57A/57B/57C/57D	

Table 8: 3- and 5-step MacAdam Ellipse Color Bin Definitions

Notes for Table 8:

1. Color binning at T_{sp}=85°C

2. Bridgelux maintains a tolerance of \pm 0.007 on x and y color coordinates in the CIE 1931 color space.

Product Bin Definitions

0.305

0.298

0.303

0.308

0.313

CIE x

0.318

0.323

0.328



Figure 1: C.I.E. 1931 Chromaticity Diagram (9 Color Bin Structure, hot-color targeted at T_{sp} =85°C)

Performance Curves

Figure 2: Drive Current vs. Voltage (T_{sp}=25°C)



Figure 3: Typical Relative Luminous Flux vs. Drive Current (T_{sp}=25°C)



Note for Figure 3:

1. Bridgelux does not recommend driving high power LEDs at low currents. Doing so may produce unpredictable results. Pulse width modulation (PWM) is recommended for dimming effects.

Performance Curves



Figure 4: Typical Relative DC Flux vs. Solder Point Temperature

Figure 5: Typical DC ccy Shift vs. Solder Point Temperature



Notes for Figures 4 & 5:

1. Characteristics shown for warm white based on 3000K and 80 CRI.

2. Characteristics shown for neutral white based on 4000K and 80 CRI.

3. Characteristics shown for cool white based on 5000K and 70 CRI.

4. For other color SKUs, the shift in color will vary. Please contact your Bridgelux Sales Representative for more information.

Performance Curves



Figure 6: Typical DC ccx Shift vs. Solder Point Temperature

Notes for Figure 6:

- 1. Characteristics shown for warm white based on 3000K and 80 CRI.
- 2. Characteristics shown for neutral white based on 4000K and 80 CRI.
- 3. Characteristics shown for cool white based on 5000K and 70 CRI.

4. For other color SKUs, the shift in color will vary. Please contact your Bridgelux Sales Representative for more information.

Typical Radiation Pattern



Figure 7: Typical Spatial Radiation Pattern at 150mA, T_{sp}=25°C

Notes for Figure 7:

1. Typical viewing angle is 120°.

2. The viewing angle is defined as the off axis angle from the centerline where Iv is $\frac{1}{2}$ of the peak value.

Figure 8: Typical Polar Radiation Pattern at 150mA, T_{sp}=25°C



Typical Color Spectrum

Figure 9: Typical Color Spectrum



Notes for Figure 9:

- 1. Color spectra measured at nominal current for T_{sp} = 25°C
- 2. Color spectra shown for warm white is 2700K and 90 CRI.
- 3. Color spectra shown for warm white is 3000K and 80 CRI.
- 4. Color spectra shown for neutral white is 4000K and 80 CRI.
- 5 Color spectra shown for cool white is 5000K and 70 CRI.
- 6. Color spectra shown for cool white is 6500K and 70 CRI.

Mechanical Dimensions

Figure 10: Drawing for SMD 3030



Notes for Figure 10:

- 1. Drawings are not to scale.
- 2. Drawing dimensions are in millimeters.
- 3. Unless otherwise specified, tolerances are ± 0.10mm.
- 4. The optical center of the LED emitter is nominally defined by the mechanical center of the emitter. The light emitting surface (LES) is centered on the mechanical center of the LED emitter to a tolerance of ± 0.2 mm

Recommended PCB Soldering Pad Pattern





Reliability

Table 9: Reliability Test Items and Conditions

No .	Items	Reference Standard	Test Conditions	Drive Current	Test Duration	Units Failed/Tested
1	Moisture/reflow Sensitivity	J-STD-020E	T _{std} = 260°C, 10sec, Precondition: 85°C, 60%RH, 168hr		3 reflows	0/22
2	Low Temperature Storage	JESD22-A119	T _a =-40°C		1000 hours	0/22
3	High Temperature Storage	JESD22-A103D	T _a =100°C		1000 hours	0/22
4	Low Temperature Operating Life	JESD22-A108D	T _a =-40°C	150mA	1000 hours	0/22
5	Temperature Humidity Operating Life	JESD22-A101C	T _{sp} =85°C, RH=85%	150mA	1000 hours	0/22
6	High Temperature Operating Life	JESD22-A108D	T _{sp} =105 [°] C	240mA	1000 hours	0/22
7	Thermal Shock	JESD22-A106B	T _a =-40°C ~100°C; Dwell : 15min; Transfer: 10sec		200 Cycle	0/22
8	Temperature Cycle	JESD22-A104E	T _a =-40°C ~100°C; Dwell at extreme temperature: 15min; Ramp rate < 105°C/min		200 Cycle	0/22
9	Electrostatic Discharge	JS-001-2012	HBM, 2KV, 1.5kΩ, 100pF, Alternately positive or negative			0/22

Passing Criteria

Item	Symbol	Test Condition	Passing Criteria
Forward Voltage	Vf	150mA	ΔVf<10%
Luminous Flux	lv	150mA	Δlv<30%
Chromaticity Coordinates	(x, y)	150mA	∆u'v'<0.007

Notes for Table 9:

1. Measurements are performed after allowing the LEDs to return to room temperature

2. $T_{\rm sld}$: reflow soldering temperature; $T_{\rm a}$: ambient temperature

Reflowing Characteristics

Figure 11 : Reflow Profile



Profile Feature	Lead Free Assembly	
Preheat: Temperature Range	180°C – 200°C	
Preheat: Time (Maximum)	120 seconds	
Peak Temperature	260°C	
Soldering Time (Maximum)	10 seconds	
Allowable Reflow Cycles	2	

Figure 12 : Pick and Place



Note for Figure 12:

1. When using a pick and place machine, choose a nozzle that has a larger diameter than the LED's emitting surface. Using a Pick-and-Place nozzle with a smaller diameter than the size of the LEDs emitting surface will cause damage and may also cause the LED to not illuminate.

Packaging

Figure 13: Emitter Reel Drawings



Note for Figure 13:

1. Drawings are not to scale. Drawing dimensions are in millimeters.

Figure 14: Emitter Tape Drawings



Note for Figure 14:

1. Drawings are not to scale. Drawing dimensions are in millimeters.

Packaging

Figure 15: Emitter Reel Packaging Drawings



Note for Figure 15: 1. Drawings are not to scale.